

**Features**

- Chip Scale Package
- Ultra Low Capacitance
- Ultra Low Leakage
- Low Clamping Voltage
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

**Maximum Ratings**

- Operating Junction Temperature Range: -55°C to +125°C
- Storage Temperature Range: -55°C to +150°C

MCC Part Number	Device Marking
CSPLC5V0LB	H

IEC61000-4-2(ESD)	Air Contact	±30KV ±30KV
Peak Pulse Current(8/20µs)	I <sub>PP</sub>	18A
Peak Pulse Power (8/20µs)	P <sub>PK</sub>	140W

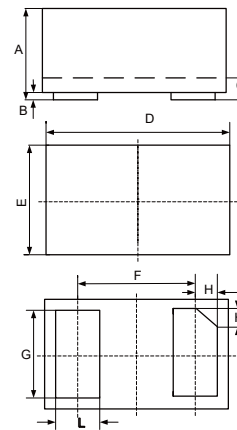
Note:  
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

**Internal Structure**



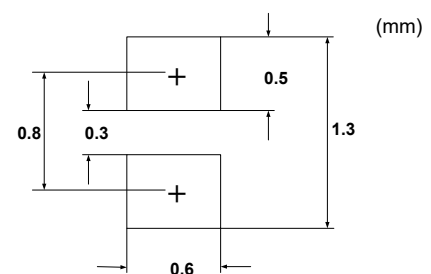
**ESD Protection Device**

**CSP1006-2**



DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.018	0.022	0.45	0.55	
B	0.000	0.002	0.00	0.05	
C	0.005	0.007	0.12	0.18	
D	0.037	0.041	0.95	1.05	
E	0.022	0.026	0.55	0.65	
F	0.026		0.650		TYP.
G	0.018	0.022	0.45	0.55	
H	0.003	0.007	0.07	0.17	
L	0.008	0.012	0.20	0.30	

**SUGGESTED SOLDER PAD LAYOUT**



**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Working Voltage	$V_{RWM}$				5	V
Reverse Breakdown Voltage	$V_{BR}$	$I_T=1mA$	6			V
Reverse Leakage Current	$I_R$	$V_{RWM}=5V$			0.5	$\mu A$
Clamping Voltage	$V_C$	$I_{PP}=1A, t_p=8/20\mu s$		6	9	V
Clamping Voltage	$V_C$	$I_{PP}=18A, t_p=8/20\mu s$		7.5	9.5	V
Junction Capacitance	$C_J$	$V_R=0V, f=1MHz$		25	30	pF

**Curve Characteristics**

Fig. 1 - 8 X 20µs Pulse Waveform

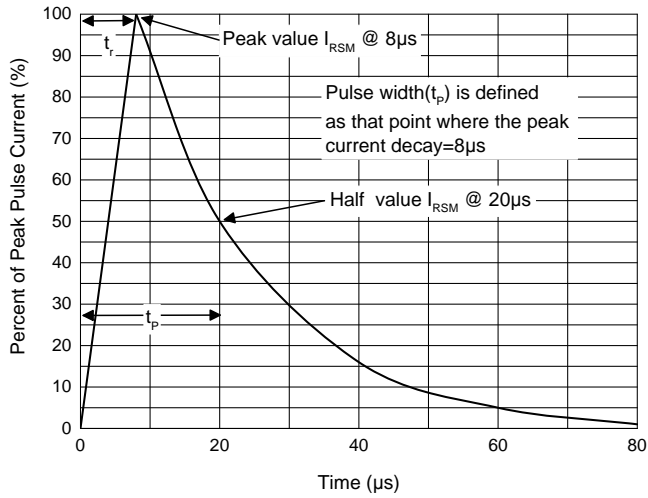


Fig. 2 - Non-Repetitive Peak Pulse Power

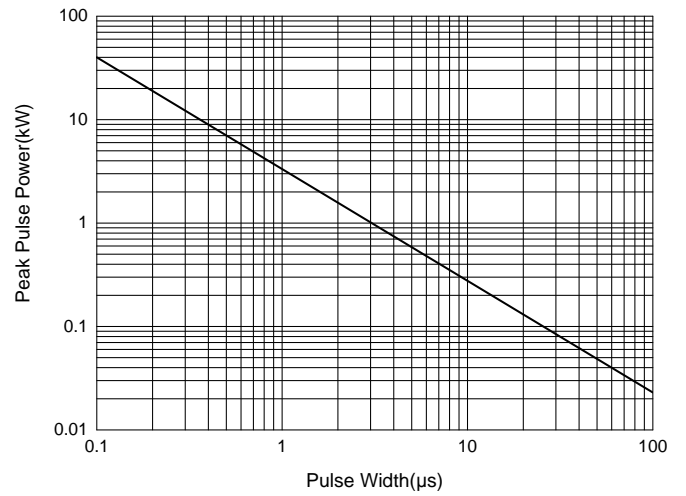


Fig. 3 - Capacitance Characteristics

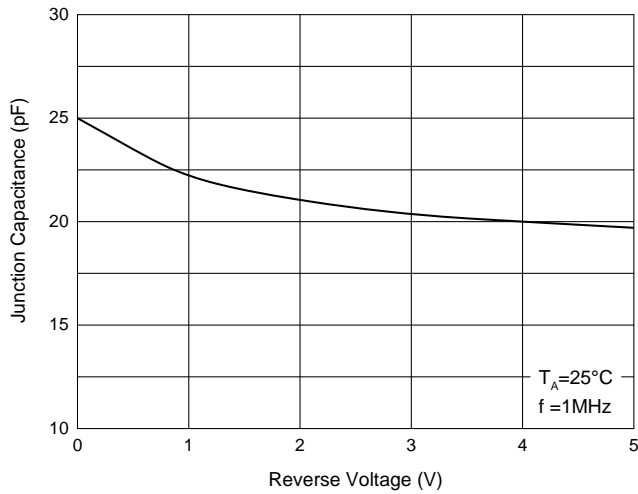


Fig. 4 - Clamping Voltage Characteristics

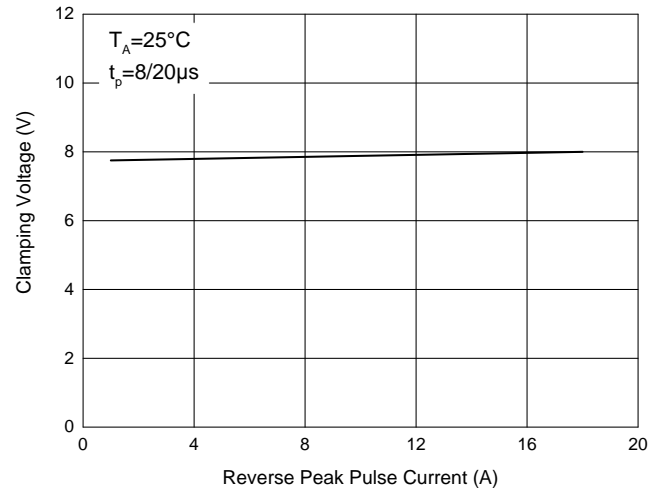


Fig. 5 - Pulse Derating Curve

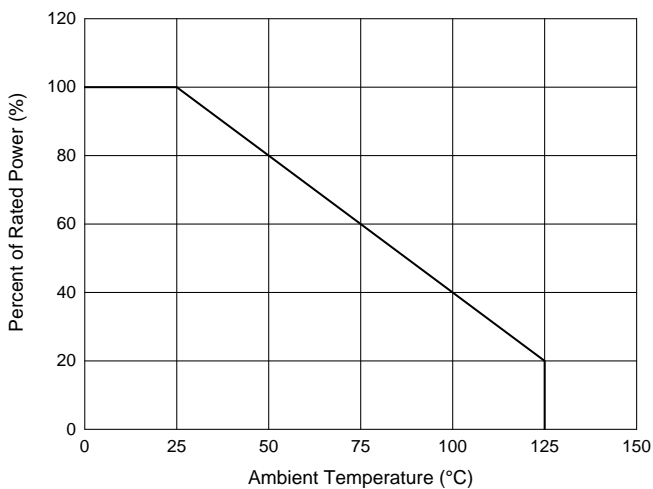


Fig. 6 - TLP Measurement

